

**AMENDMENTS TO THE SPECIFICATION**

Please amend page 1, paragraph [0001] as follows:

This application is a U.S. National Phase application of PCT/US2004/014209, filed  
May 7, 2004, which claims the benefit of United States Provisional Application No.  
60/468,801, filed 7 May 2003 and entitled "LAMINATED THERMAL MANAGEMENT  
COIN/SLUG FOR PRINTED CIRCUIT BOARDS," the entirety entireties of which is are  
incorporated herein by reference.